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Sp	ecification	
Part Number:	MC22005A12W-VNMLB	
Version:		
Date:		
	Revision	

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1.General Specification

The Features is described as follow:

■ Module dimension: 115.0 x 36.0 x 13.9 (MAX) mm

■ View area: 85.0 x 18.6 mm

■ Active area: 73.5 x 11.5 mm

■ Number of Characters: 20 characters x 2 Lines

■ Dot size: 0.60 x 0.65 mm

■ Dot pitch: 0.65 x 0.70 mm

■ Character size: 3.20 x 5.55 mm

■ Character pitch: 3.70 x 5.95 mm

■ LCD type: VA Negative Transmissive

■ Duty: 1/16

■ View direction: 12 o'clock

■ Backlight Type: LED, Blue(High light)

■ IC:ST7066Ugn • manufacture • supply

Midas LCD Part Number System

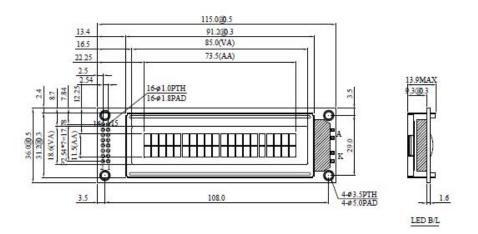
```
MC
        COG
                 132033
                                 Α
                                                                                 S
 1
          2
                      3
                                 4
                                        5
                                               6
                                                      7
                                                             8
                                                                    9
                                                                                10
                                                                                       11
                                                                                               12
                                                                                                      13
                                                                                                              14
                                                                                                                     15
                                                                                                                            16
1
                   MC: Midas Components
2
         =
                   Blank: COB (chip on board) COG: chip on glass
3
         =
                   No of dots
                                      (e.g. 240064 = 240 \times 64 \text{ dots})
                                                                             (e.g. 21605 = 2 \times 16 5 mm C.H.)
                   Series
4
                   Series Variant:
                                      A to Z - see addendum
5
                   3: 3 o'clock
                                                         9: 9 o'clock
                                                                             12: 12 o'clock
                                      6: 6 o'clock
6
7
                   S: Normal (0 to + 50 deg C) W: Wide temp. (-20 to + 70 deg C) X: Extended temp (-30 + 80 Deg C)
8
                   Character Set
                   Blank: Standard (English/Japanese)
                   C: Chinese Simplified (Graphic Displays only)
                   CB: Chinese Big 5 (Graphic Displays only)
                   H: Hebrew
                   K: European (std) (English/German/French/Greek)
                   L: English/Japanese (special)
                   M: European (English/Scandinavian)
                   R: Cyrillic
                   W: European (English/Greek)
                   U: European (English/Scandinavian/Icelandic)
                   J: Asian/Arabic
9
         =
                   Bezel Height (where applicable / available)
                                                      Common
                                                                     Array
                             Top of Bezel to Top
                                                                     or Edge
                                                      (via pins 1
                                    of PCB
                                                        and 2)
                                                                       Lit
                             9.5mm / not
                    Blank
                                                       Common
                                                                     Array
                             applicable
                    2
                             8.9 \mathrm{mm}
                                                       Common
                                                                      Array
                    3
                             7.8 \ \mathrm{mm}
                                                       Separate
                                                                     Array
                    4
                             7.8 \ \mathrm{mm}
                                                       Common
                                                                     Array
                    5
                             9.5 \text{ mm}
                                                       Separate
                                                                     Array
                    6
                             7~\mathrm{mm}
                                                       Common
                                                                     Array
                    7
                             7~\mathrm{mm}
                                                       Separate
                                                                      Array
                    8
                             6.4 \ \mathrm{mm}
                                                      {\bf Common}
                                                                      Edge
                    9
                             6.4 \text{ mm}
                                                       Separate
                                                                      Edge
                    A
                             5.5 \text{ mm}
                                                       Common
                                                                      Edge
                    В
                             5.5 \text{ mm}
                                                       Separate
                                                                      Edge
                    D
                             6.0mm
                                                       Separate
                                                                      Edge
                    \mathbf{E}
                             5.0mm
                                                       Separate
                                                                      Edge
                             4.7mm
                                                                      Edge
                    F
                                                       Common
                    G
                             3.7mm
                                                       Separate
                                                                       \mathbf{EL}
10
         =
                   T: TN S: STN B: STN Blue G: STN Grey F: FSTN F2: FFSTN V: VATN Z: Zero Power (Bi-Stable)
11
         =
                   P: Positive N: Negative
12
         =
                   R: Reflective M: Transmissive T: Transflective
13
                   Backlight: Blank: Reflective L: LED
14
                   Backlight Colour: Y: Yellow-Green W: White B: Blue R: Red A: Amber O: Orange G: Green RGB: R.G.B.
                   If Z (Zero Power): WB: White on blue GB: Green on black YB: Yellow on black YPB: Yellow on pink and/or blue
15
         =
                   Driver Chip:
                                      Blank: Standard I: I<sup>2</sup>C T: Toshiba T6963C A: Avant SAP1024B R: Raio RA8835
```

Voltage Variant: e.g. 3 = 3v

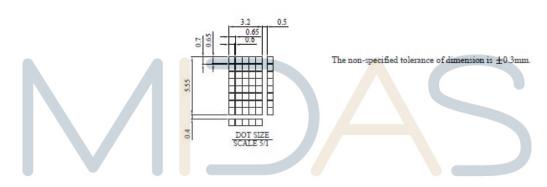
3.Interface Pin Function

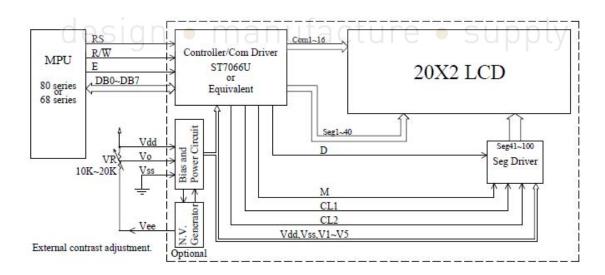
Pin No.	Symbol	Level	Description
1	V _{SS}	0V	Ground
2	V_{DD}	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read (Module> MPU) L: Write(MPU> Module)
6	E	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	D <mark>at</mark> a bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	Vee	_	Negative Voltage Output
16	K	_	Power supply for B/L -

4. Contour Drawing & Block Diagram



PIN NO.	SYMBOL
1	Vss
2	Vdd
3	Vo
4	RS
5	R/W
6	E
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	VEE
16	K





Character located DDRAM address DDRAM address 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 00 01 02 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F 10 11 12 13 40 41 42 43 44 45 46 47 48 49 4A 4B 4C 4D 4E 4F 50 51 52 53

5.Character Generator ROM Pattern

Table.2

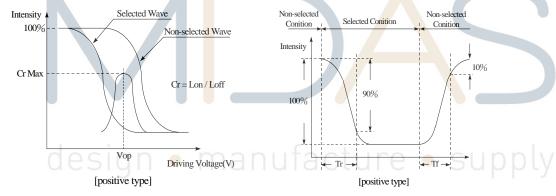
Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL			LHHH	HLLL	HLLH	HLHL	нгнн	HHLL	HHLH	HHHL	нннн
LLLL	CG RAM (1)					 	•	:::: -					·:;]	₩.	C:C	! ∷•
LLLH	(2)			1			-:::	-:::			:::		:: -	<u> </u>	.iii	:::
LLHL	(3)		11	:::			<u> </u>	!-"-			1"	·¶.	!!J	<u>:</u> :::'	ļiii:	I:::I
LLHH	(4)		#		<u> </u>	•	: <u></u> .	::::-			!	۳ <u>.</u> :	·ji··	1	::::-	.:-:•
LHLL	(5)		:#:	::	<u> </u>	"	:::	ŧ			٠.		ļ	:	1	::::
LHLH	(6)		:.·:					ll			::	A			CS:	10.1
LHHL	(7)			:::.				١.,.١								
LHHH	(8)			7			-	اا			-:::		:::		·	37.
HLLL	(1)					\times			t –	_ + .	·:[·!			.,I'''	
HLLH	(2)	ue	3.		I				la	CH		9.1.	.!		20	Ŋ
HLHL	(3)		:-[-:	::	"	:::	. <u>.</u> i	::::			:::::		1	<u>.</u>	i	:: ::
нгнн	(4)			::	H.	Ĭ	! ::	4			:::I	!!	<u></u>		:-:]==;
HHLL	(5)		:=	-:.		4	1.	I			- -::	<u></u> .:	·]	!" <u>;</u> :!	·: :-	::: <u> </u>
HHLH	(6)				ri		[```]	}				. :	••••	:	₩	:
нннг	(7)		==	:-	 - -	••••	l-"i	:				1::		•••	l ^{:::} ı	
нннн	(8)		*	• • • • • • • • • • • • • • • • • • • •			: <u></u> :	- !			• :•	١ا	·-:	iii	1:::1	

6.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧10	_	60	_	ψ= 180°
View Angle	θ	CR≧10	_	25	_	ψ= 0°
View Angle	θ	CR≧10	_	40	_	ψ= 90°
	θ	CR≧10	_	40	_	ψ= 270°
Contrast Ratio	CR	_	10	_	_	_
Doononee Time	T rise	_	_	300	350	ms
Response Time	T fall	_	_	300	350	ms



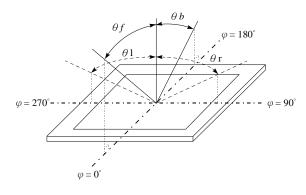
Definition of Response Time (Tr, Tf)



Conditions:

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle(CR≥2)



7. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T _{OP}	-20	_	+70	
Storage Temperature	T _{ST}	-30	_	+80	
Input Voltage	Vı	V _{SS}	_	V_{DD}	V
Supply Voltage For Logic	VDD-V _{SS}	-0.3	_	7	V
Supply Voltage For LCD	V_{DD} - V_{o}	-0.3	_	13	V



8. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
Supply Voltage For LCD		Ta=-20°C	_	_	_	V
*Note	V_{DD} - V_{0}	Ta=25°℃	8.2	8.5	8.8	V
		Ta=70°C	_	_	_	V
Input High Volt.	V_{IH}	_	0.7 V _{DD}	_	V_{DD}	V
Input Low Volt.	V _{IL}	_	Vss	_	0.6	V
Output High Volt.	V _{OH}	_	3.9	_	V_{DD}	V
Output Low Volt.	V _{OL}		0	-	0.4	V
Supply Current	I _{DD}	V _{DD} =5.0V	_	1.0	1	mA

^{*}Note: Please design the VOP adjustment circuit on customer's main board



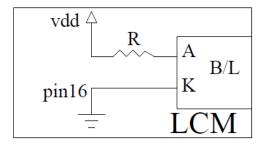
9.Backlight Information

Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	_	96	120	mA	V=5.0V
Supply Voltage	V	4.9	5.0	5.1	V	_
Reverse Voltage	VR	_	_	5	V	_
Luminance (Without LCD)	IV	248	310	_	CD/M ²	ILED=96mA
Wave Length	λр	460	470	480	nm	ILED=96mA
LED Life Time					Λ	ILED=96mA
(For Reference	-//	_	50K	-	Hr.	25 ,50-60%RH,
only)						(Note 1)
Color	Blue(high	light)				

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Drive from Vdd, Pin 16



10.Reliability

Content of Reliability Test (Wide temperature, -20 ~70)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 ,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60 ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20 25 70	-20 /70 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

Note1: No dew condensation to be observed.

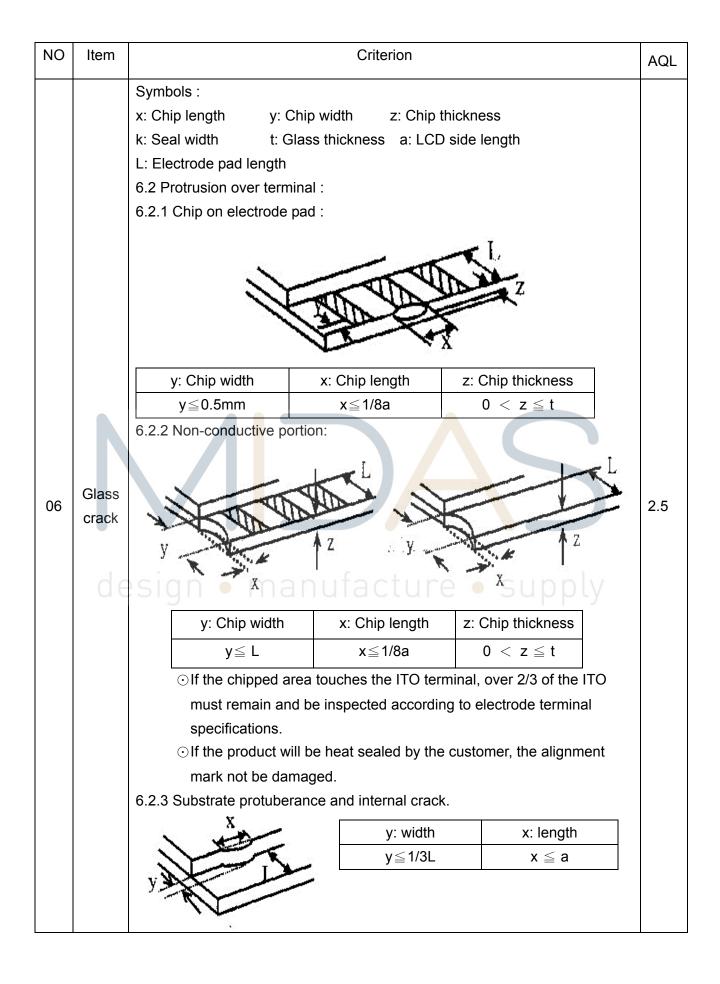
Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

11.Inspection specification

NO	Item			Criterion		AQL
01	Electrical Testing	defect. 1.2 Missing cha 1.3 Display malf 1.4 No function	racter , do function. or no disposumption eagrangle decorates.	lay. exceeds product sp		0.65
02	Black or white spots on LCD (display only)	three white o	or black sp	•	mm, no more than s or lines within 3mm	2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi = (x + y) / X$ $3.2 \text{ Line type : (a)}$	2 ↓ Y	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are vijudge using black specifications, note to find, must chespecify direction	ck spot ot easy eck in	Size Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

NO	Item		Criterion		AQL
05	Scratches	Follow NO.3 LCD black	spots, white spots, cor	ntamination	
05	Chipped glass	Symbols Define: x: Chip length k: Seal width t: Chip length t: Chip length 6.1 General glass chip is chi	Chip width z: Chip Glass thickness a: LC : face and crack betwee y: Chip width Not over viewing area Not exceed 1/3k chips, x is total length y: Chip width Not over viewing area Not exceed 1/3k	x: Chip length x ≤ 1/8a x ≤ 1/8a x ≤ 1/8a x ≤ 1/8a x ≤ 1/8a	2.5



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB · COB desig	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB 	2.5 2.5 0.65 2.5 0.65 2.5 2.5 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65

NO	Item	Criterion							
12		12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.							
	General appearance	12.2 No cracks on interface pin (OLB) of TCP.12.3 No contamination, solder residue or solder balls on product.12.4 The IC on the TCP may not be damaged, circuits.							
						12.5 The uppermost edge of the protective strip on the interface			
						pin must be present or look as if it cause the interface pin to			
		sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened.							
						12.8 Pin type must match type in specification sheet.			
						12.9 LCD pin loose or missing pins.			
		 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product 							
							specification sheet. 12.12 Visual defect outside of VA is not considered to be rejection.		

12. Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) T aaæ have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9)T aaæ have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Taæ have the right to modify the version.)

13. Material List of Components for RoHs

1. T aaæ Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs			
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm			
Above limited value is set up according to RoHS									

2.Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250 ,30 seconds Max.;

Connector soldering wave or hand soldering: 320 , 10 seconds max.

(3) Temp. curve of reflow, max. Temp.: 235±5

Recommended customer's soldering temp. of connector: 280, 3 seconds.

14. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

